

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: T. WADA, et al
Application No.: 10/812,869
Filed: March 31, 2004
For: METHOD OF MANUFACTURING A SEMICONDUCTOR
DEVICE

PETITION UNDER 37 CFR § 1.47(a)

Mail Stop Missing Parts
Commissioner For Patents
P.O. Box 1450
Alexandria, VA 22313-1450

September 14, 2004

Sir:

The following joint inventors make application for patent for themselves and on behalf of the non-signing inventor, Mr. Takashi Wada:

- (1) Noriyuki Oroku; and
- (2) Hiroshi Maki.

It is respectfully submitted that Mr. Takeshi Wada could not be found or reached, for executing the Declaration Under 37 CFR § 1.63 for the above-identified application, after diligent effort. For establishing such diligent effort, note the enclosed "Declaration of Yoshitsugu Harada Presenting Statement Of Facts Under 37 CFR § 1.47 (hereinafter "Declaration of Harada"). In particular, note that Mr. Wada retired from Hitachi, Ltd. in March 2003; and that in an attempt to have Mr. Wada review the application papers and drawings in the application, the last known address of Mr. Wada and of his parents, and the last known telephone number of Mr. Wada, were obtained. Note Item 4 of the enclosed Declaration of Harada. See also Items 5 and 7 on page 2 of the enclosed Declaration of Harada, noting that on March 4 and 10, 2004, the application papers, together with a

Declaration and an Assignment, were respectively sent to the last known address of Mr. Wada's parents and to the last known address of Mr. Wada, by registered mail; but that each of these were returned by the Post Office, as set forth in Items 6 and 8 on page 2 of the enclosed Declaration of Harada and as seen in Exhibits I and II attached to this Declaration. As seen in Item 10 on page 3 of this Declaration of Harada, Mr. Wada was telephoned at his last known telephone number, but the line was not available.

Note also Item 12 on page 3 of this Declaration of Harada, indicating that the last known address of Mr. Wada is 9-19-K202, Gakuennishimachi 2-chome, Kodaira-shi, Tokyo 187-0045, Japan.

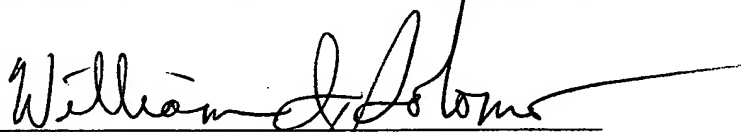
Also enclosed is the necessary fee set forth in 37 CFR § 1.17(h).

In view of all of the foregoing, granting of this Petition, thereby granting the above-identified application a status under 37 CFR § 1.47(a), is respectfully requested.

Please charge any shortage in the fees due in connection with the filing of this paper, including extension of time fees, to the deposit account of Antonelli, Terry, Stout & Kraus, LLP, Deposit Account No. 01-2135 (Case No.: 501.43640X00), and please credit any excess fees to such deposit account.

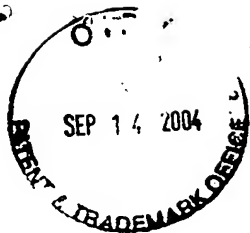
Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP

A handwritten signature in black ink, appearing to read "William I. Solomon", written over a horizontal line.

William I. Solomon
Registration No. 28,565

WIS/sjg



501.43640X00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: T. WADA, et al.
Application No.: 10/812,869
Filed: March 31, 2004
For: METHOD OF MANUFACTURING A SEMICONDUCTOR
DEVICE
Group: Not yet assigned.
Examiner: Not yet assigned

DECLARATION OF YOSHITSUGU HARADA PRESENTING STATEMENT OF
FACTS UNDER 37 CFR § 1.47

Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

I, Yoshitsugu HARADA, a citizen of Japan, residing at 29-2, Tsudamachi
3-chome, Kodaira-shi, Tokyo 187-0025, Japan, DECLARE THAT:

1. Mr. Takashi Wada is named as a joint inventor in Application
No. 10/812,869, filed March 31, 2004 (hereinafter the above-identified application).
2. Mr. Wada retired from Hitachi, Ltd. in March 2003.
3. Under my supervision, the following actions were performed to have Mr.
Wada review the application papers for the above-identified application, and join in
the application.
4. We obtained the last known address of Mr. Wada, the last known
address of the parents of Mr. Wada, and the last known telephone number of Mr.

Wada, from the supervisor of the department to which Mr. Wada belonged.

5. On March 4, 2004, we sent the application papers (specification, claims, Abstract and drawing figures) of the above-identified application, together with a Declaration naming Mr. Wada as a joint inventor and to be signed by him, and with an Assignment, to the last known address of Mr. Wada's parents, by registered mail; we had been informed by Mr. Wada's supervisor that he had already moved from his last known address, and, accordingly, we sent the mail to his parents' address.

6. The mail was returned to us by the Post Office with the notice that the mail could not be delivered because the new address of Mr. Wada was not known; a copy of the returned envelope of the mail sent to Mr. Wada's parents is enclosed herewith as Exhibit I.

7. On March 10, 2004, we sent the application papers (specification, claims, Abstract and drawing figures) of the above-identified application, together with a Declaration naming Mr. Wada as a joint inventor and to be signed by him, and with an Assignment, to the last known address of Mr. Wada that he left with his supervisor, by registered mail.

8. The mail sent to the address of Mr. Wada that he left with his supervisor was returned to us by the Post Office with the notice that the mail could not be delivered because a new address of Mr. Wada was not known; a copy of the returned envelope of the mail sent to the address of Mr. Wada that he left with his supervisor is enclosed herewith as Exhibit II.

9. As seen in Items 6 and 8 in the foregoing, the application papers with

the Declaration and Assignment were not delivered to Mr. Takashi Wada.

10. We telephoned Mr. Wada at his last known telephone number that he left with his supervisor; however, the line was not available.

11. The foregoing shows that while diligent efforts were made to find Mr. Wada, such efforts were not successful.

12. The last known address of Mr. Takashi Wada is 9-19-K202, Gakuennishimachi 2-chome, Kodaira-shi, Tokyo 187-0045, Japan.

The undersigned hereby declares that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements are made with the knowledge that willful false statements and the like so made are punishable by fine, or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.


Yoshitsugu HARADA

July 2, 2004
Date

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小平郵便局
料金後納
郵便

O I P E J C O
SEP 14 2004
REMARK

郵便番号

〒318-0024

茨城県高萩市秋山2421

和田 隆 様

転居先不明で
配達できません

高萩

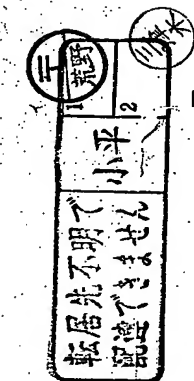
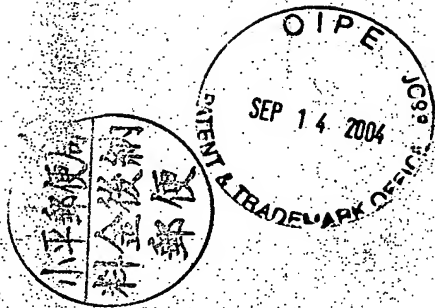


319-42-83302-0

EXHIBIT I

185-0014

東京都国分寺市東恋ヶ窪 3-1-1



〒187-0045

東京都小平市学園西町2-9-19

シャングリラK202

和 田 隆 様

EXHIBIT II

株式会社 日立超LSIシステムズ

社 〒185-0014 東京都国分寺市東恋ヶ窪3-1-1

TEL 042-359-2271 (代表)

FAX 042-359-2266

知的財産センター 右澤

